TACT Switch™ **0.55mm Height Low-profile (Surface Mount Type)**

SKRB Series





4.8×4.8mm with height of 0.55mm. Compact low & profile.

Detector

Push

Slide

Rotary

Encoders

Power

Dual-in-line Package Type

TACT Switch™

Custom-Products

|--|

Product Line

1 TOUGUE EITO								
Product No.	Operating force	Operating direction	Travel (mm)	Rating (max.)	Rating (min.)	Operating life (5mA 5V DC)	Initial contact resistance	Minimum order unit (pcs.)
SKRBAGE010	1.1N		0.15	50mA 12V DC		2,000,000cycles	100m	10,000
SKRBAAE010	1.57N	Vertical			10 <i>μ</i> Α	1,000,000cycles		
SKRBACE010	2.55N	Vertical	0.2		1V DC	500,000cycles	max.	10,000
SKRBAKE010	3.5N					200,000cycles		

Specification of Embossed Taping Package (Taping Packaging for Auto-insertion) Reel Size Unit:mm

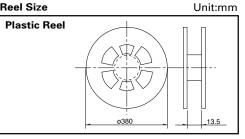
Sharp Feeling

Soft Feeling

Snap-in Type

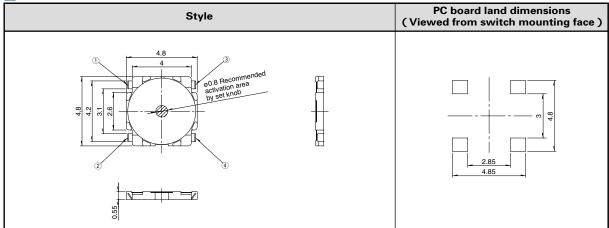
Surface Mount Type

Radial Type

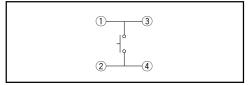


Numl					
1 reel	1 case /Japan	1 case /export packing	Tape width (mm)		
10,000	100,000	100,000	12		

■ Dimensions Unit:mm



Circuit Diagram



Note

- 1. Please place purchase orders for taping products per minimum order unit (1 reel or a case).
- 2. For $\,$ 330mm diameter reel requirements, please contact us.

Refer to P.306 for soldering conditions.

List of Varieties

Detector

Push

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TACT Switch™

Custom-**Products**

Sharp Feeling Soft Feeling Snap-in Type

Surface Mount Type Radial

Type

Sharp Feeling Type													
Series		SKQU	SKQB	SKQE	SKHC	SKHK	SKRW	SKRM	SKQR	SKRB	SKRR	SKQG	
Photo		◆			0	*	(0			(
Туре			Snap-in					Surface mount					
Features		4-direction switch + push switch	Water-proof Horizontal type	Long Life		Long Stem				Low-profile and long life	Low-profile		
Oper	Ver	Vertical											
Operating direction	Horiz	ontal											
		w	10	11.5		12		2.7	4.5	4.8		7.5	F 2
	nsions m)	D	10	11.9		12		3.7 4.5				7	5.2
		Н	7.1	11.3	4.	.3	12	0.35	0.4	0.5	0.55	0.6	0.8
fo	ation rce erage	1N 5N	See the relevant pages for respective product descriptions	•	‡	1	•	1	†	‡		‡	\uparrow
Ground terminal													
Operating temperature -30 to +85 range													
Elec	Insulation resistance 100M min. 100V DC												
trical mance	Insulation resistance 100M min. 100V DC												
Durability	Vibra	ation	10 to 55 to 10Hz/min., the amplitude is 1.5mm for all the frequencies, in the 3 direction of X, Y and Z for 2hours respectively										
bility	Lifet	time	Shall be in accordance with individual specifications.										
Cold -30 ± 2 for 96h													
ental	Damp heat 60 ± 2 , 90 to 95%RH for 96h												
	Page		482	265	267	268	270	271	272	273	274	275	276

W: Width. The most outer dimension excluding terminal portion.
 D: Depth. The most outer dimension excluding terminal portion.
 H: Height. The minimum dimension if there are variances.

TACT Switch™ Soldering Conditions306

Note

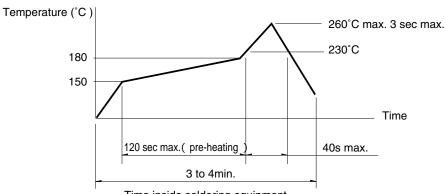
The automotive operating temperature range to be individually discussed upon request.

Soldering Conditions

Condition for Reflow

Available for Surface Mount Type.

- 1. Heating method: Double heating method with infrared heater.
- 2. Temperature measurement: Thermocouple 0.1 to 0.2 CA(K)or CC(T)at solder joints(copper foil surface). A heat resistive tape should be used to fix thermocouple.
- 3. Temperature profile



Time inside soldering equipment

Detector

Push

Slide

Rotary

Encoders

Power

Dual-in-line Package Type

TACT Switch[™]

Custom-Products

Note

- 1. The above temperature shall be measured on the mounting surface of a PC board. There are cases where the PC board's temperature greatly differs from that of the switch, depending on the material, size, thickness of PC boards and others. The above-stated conditions shall also apply to switch surface temperatures.
- 2. Soldering conditions differ depending on reflow soldering machines. Prior verification of soldering condition is highly recommended.

Sharp Feeling

Soft Feeling

Snap-in Type Surface Mount Type

Radial Type

Conditions for Auto-dip Available for Snap-in Type and Radial Type (Except SKHJ, SKHL, SKQJ, SKQK, SKEG series)

Items	Condition				
Flux built-up	Mounting surface should not be exposed to fluk				
Preheating temperature	Ambient temperature of the soldered surface of PC board. 100 max.				
Preheating time	60s max.				
Soldering temperature	260 max.				
Duration of immersion	5s max.				
Number of soldering	2times max.				

■ Manual Soldering (Except SKRT Series)

ltems	Condition
Soldering temperature	350 max.
Duration of soldering	3s max.
Capacity of soldering iron	60W max.

Notes

- 1. Consult with us for availability of TACT Switch $^{\text{TM}}$ washing.
- 2. Prevent flux penetration from the top side of the TACT Switch $^{\!\top\! M}\!.$
- 3. Switch terminals and a PC board should not be coated with flux prior to soldering.
- 4. The second soldering should be done after the switch is stable with normal temperature.
- Use the flux with a specific gravity of min 0.81.(EC-19S-8 by TAMURA Corporation, or equivalents.)